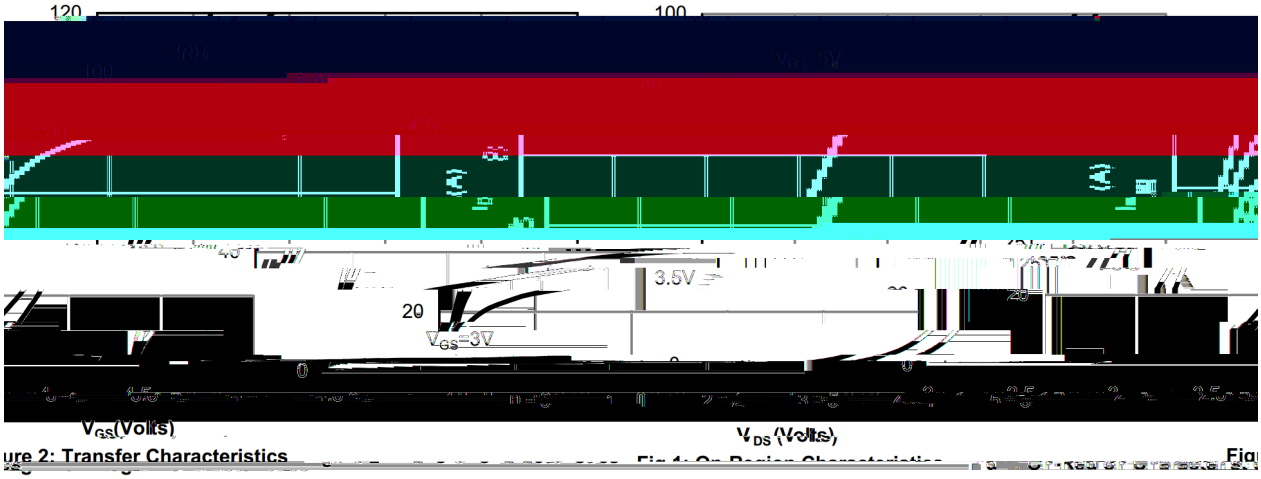
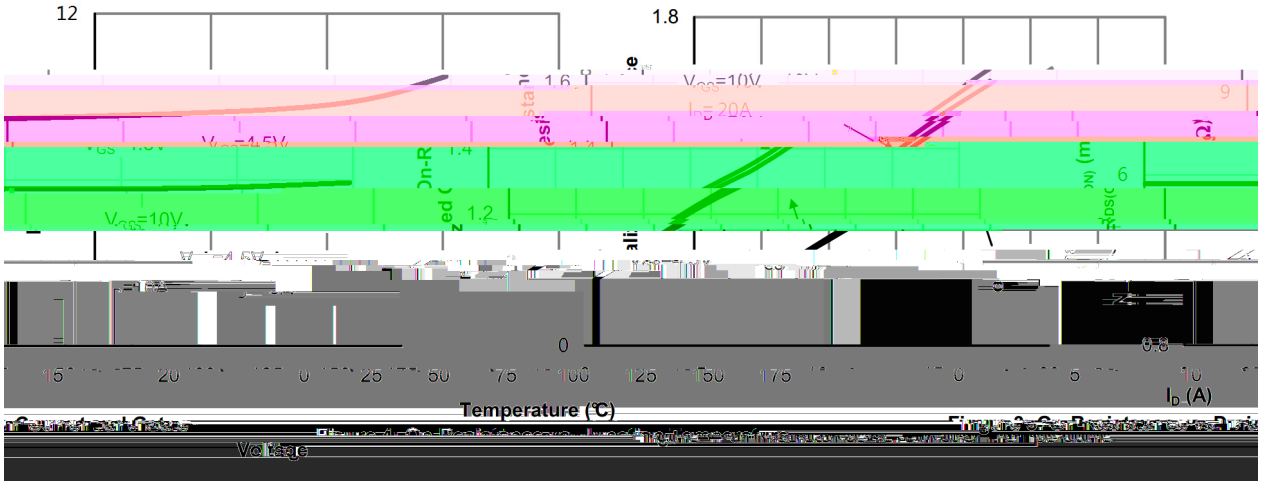
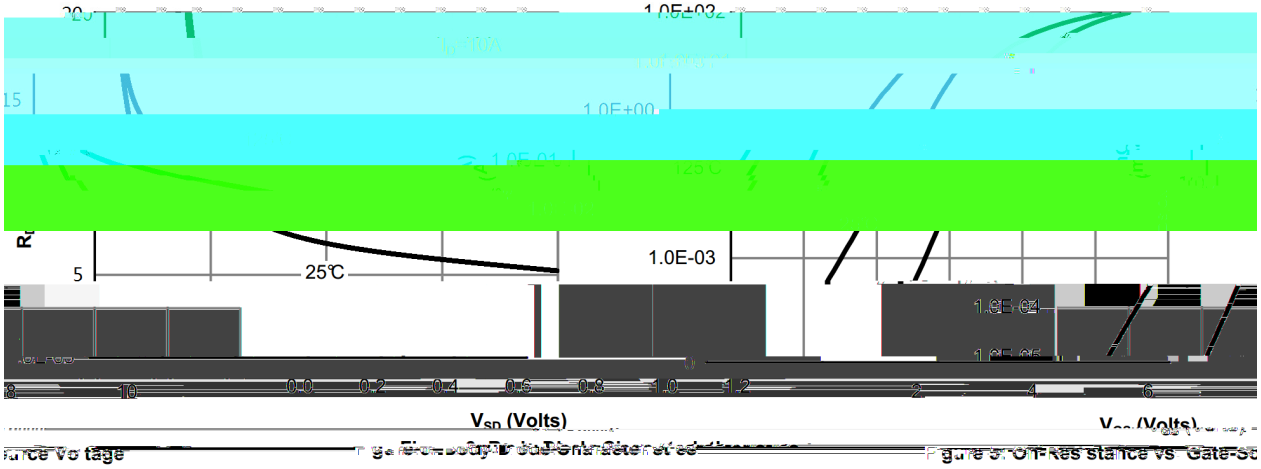
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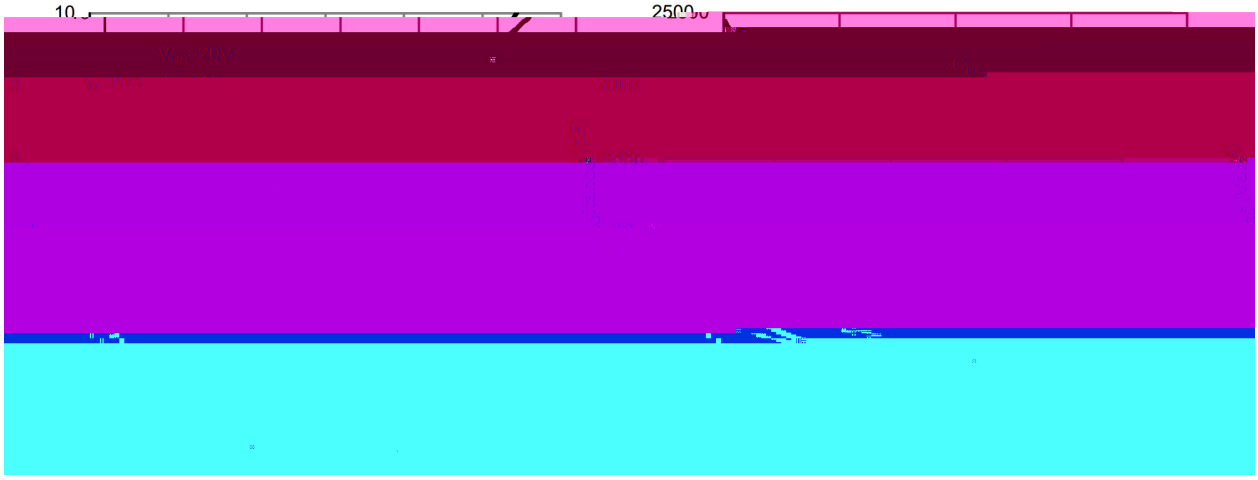


ure 2: Transfer Characteristics Fig





ance Voltage Figure 5: Body Diode Characteristics Figure 6: On-Resistance vs. Gate-So



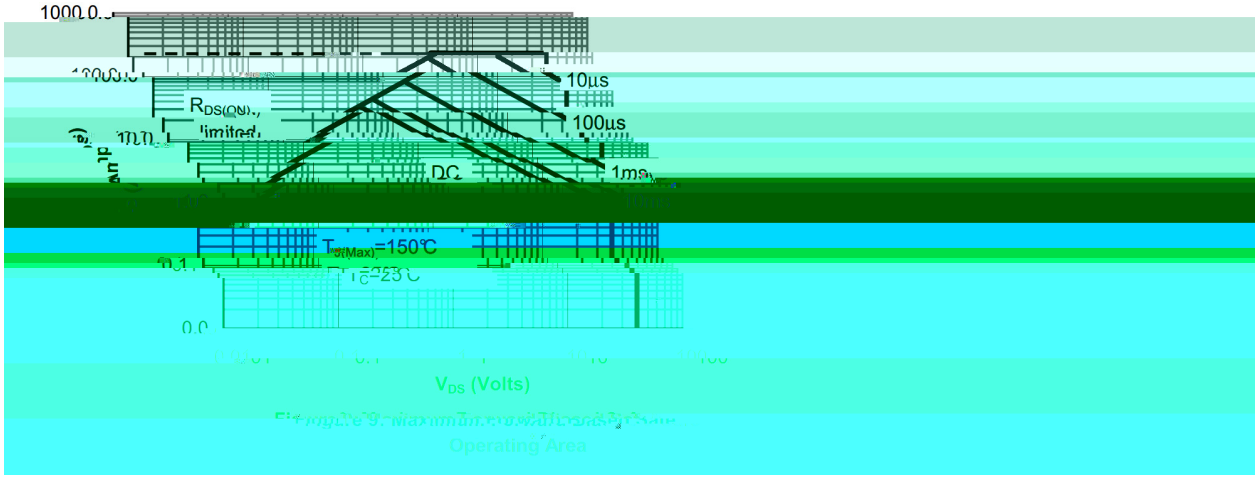
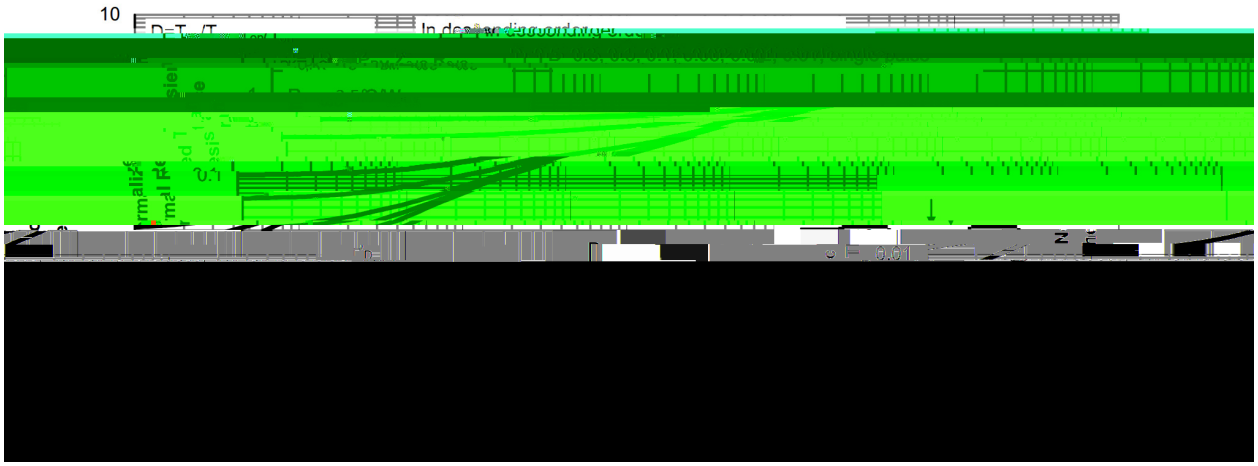
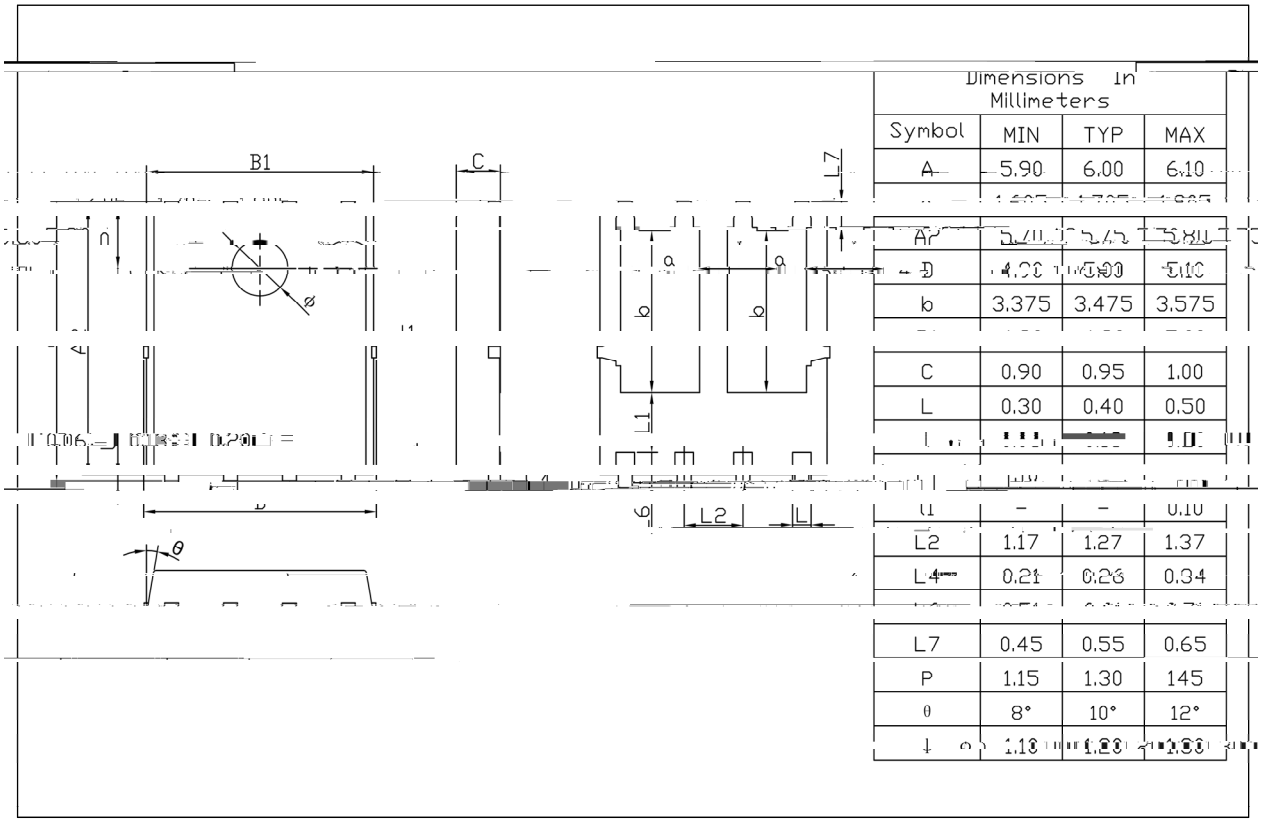


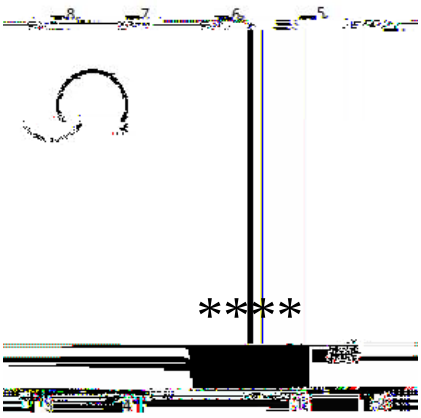
Figure 9: Maximum Forward Biased Safe Operating Area





Dimensions In Millimeters			
Symbol	MIN	TYP	MAX
A	5.90	6.00	6.10
[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]	[illegible]
b	3.375	3.475	3.575
[illegible]	[illegible]	[illegible]	[illegible]
C	0.90	0.95	1.00
L	0.30	0.40	0.50
[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	–	–	0.10
L2	1.17	1.27	1.37
[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]	[illegible]
L7	0.45	0.55	0.65
P	1.15	1.30	145
θ	8°	10°	12°
[illegible]	[illegible]	[illegible]	[illegible]

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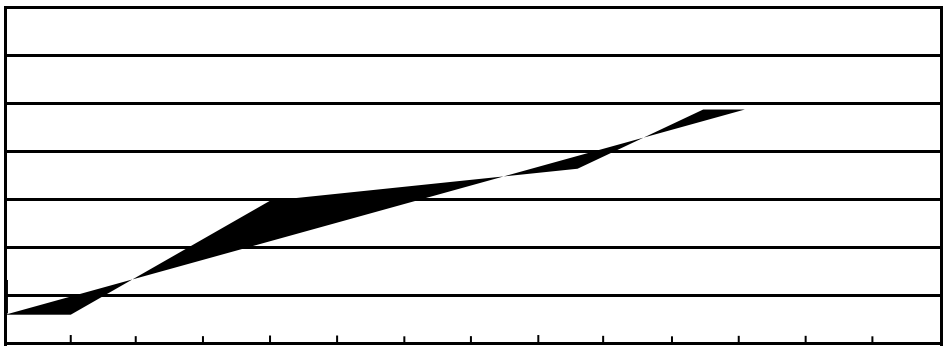
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Temperature Profile for IR Reflow Soldering(Pb-Free)



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